

STY25NA60

N - CHANNEL 600V - 0.225 Ω - 25 A - Max247 EXSTREMELY LOW GATE CHARGE POWER MOSFET

TYPE	V _{DSS}	R _{DS(on)}	ID
STY25NA60	600 V	< 0.24 Ω	25 A

- TYPICAL R_{DS(on)} = 0.225 Ω
- EFFICIENT AND RELIABLE MOUNTING THROUGH CLIP
- ± 30V GATE TO SOURCE VOLTAGE RATING
- 100% AVALANCHE TESTED
- LOW INTRINSIC CAPACITANCE
- GATE CHARGE MINIMIZED
- REDUCED VOLTAGE SPREAD

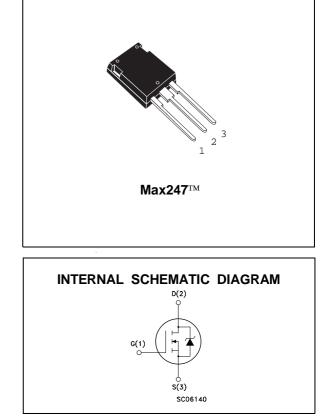
DESCRIPTION

The Max247[™] package is a new high volume power package exibiting the same footprint as the industry standard TO-247, but designed to accomodate much larger silicon chips, normally supplied in bigger packages such as TO-264.The increased die capacity makes the device idealto reduce component count in multiple paralleled designs and save board space with respect to larger packages.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLY (SMPS)
- DC-AC CONVERTER FOR WELDING EQUIPMENT AND UNINTERRUPTABLE POWER SUPPLY AND MOTOR DRIVE

ABSOLUTE MAXIMUM RATINGS



Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage (V _{GS} = 0)	600	V
V_{DGR}	Drain- gate Voltage (R_{GS} = 20 k Ω)	600	V
V _{GS}	Gate-source Voltage	± 30	V
Ι _D	Drain Current (continuous) at T _c = 25 °C	25	А
ID	Drain Current (continuous) at T _c = 100 °C	16.5	А
I _{DM} (●)	Drain Current (pulsed)	100	А
P _{tot}	Total Dissipation at $T_c = 25 \ ^{\circ}C$	300	W
	Derating Factor	2.4	W/°C
T _{stg}	Storage Temperature	-55 to 150	°C
Тj	Max. Operating Junction Temperature	150	°C

(•) Pulse width limited by safe operating area

THERMAL DATA

AVALANCHE CHARACTERISTICS

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max)	25	A
E _{AS}	Single Pulse Avalanche Energy (starting T _j = 25 °C, I _D = I _{AR} , V _{DD} = 50 V)	3000	mJ

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}C$ unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A$ $V_{GS} = 0$	600			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T_c = 125 °C			50 500	μΑ μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	$V_{GS} = \pm 30 V$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static Drain-source On Resistance	$V_{GS} = 10 \text{ V}$ $I_D = 12.5 \text{ A}$		0.225	0.24	Ω
I _{D(on)}	On State Drain Current	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $V_{GS} = 10 V$	25			A

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 12.5 \text{ A}$	20			S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 V$ f = 1 MHz $V_{GS} = 0$		6200 690 195		pF pF pF

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ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on delay Time Rise Time			45 70		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 480 \text{ V}$ $I_{D} = 25 \text{ A}$ $V_{GS} = 10 \text{ V}$		240 25 115	315	nC nC nC

SWITCHING OFF

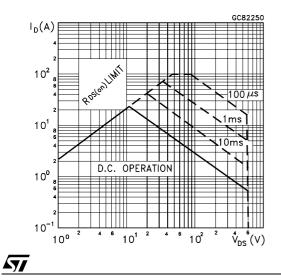
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _f	Off-voltage Rise Time Fall Time Cross-over Time	$V_{DD} = 480 \text{ V} \qquad I_D = 25 \text{ A}$ $R_G = 4.7 \Omega \qquad V_{GS} = 10 \text{ V}$ (see test circuit, figure 5)		70 25 105		ns ns ns

SOURCE DRAIN DIODE

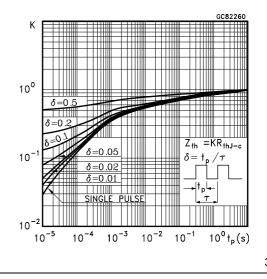
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (●)	Source-drain Current Source-drain Current (pulsed)				25 100	A A
V _{SD} (*)	Forward On Voltage	$I_{SD} = 25 \text{ A} V_{GS} = 0$			2	V
t _{rr}	Reverse Recovery Time	$I_{SD} = 25 A$ di/dt = 100 A/µs $V_{DD} = 100 V$ $T_i = 150 °C$		840		ns
Q _{rr}	Reverse Recovery Charge	(see test circuit, figure 5)		19.5		μC
I _{RRM}	Reverse Recovery Current			46.5		A

(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(•) Pulse width limited by safe operating area

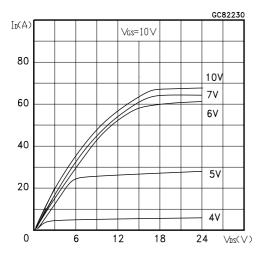
Safe Operating Area



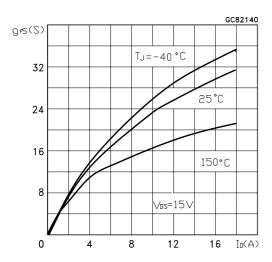
Thermal Impedance



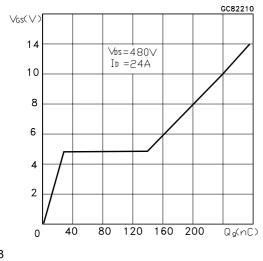
Output Characteristics



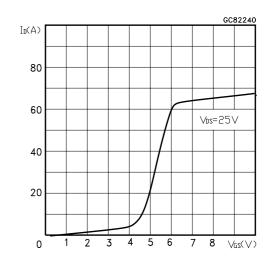
Transconductance

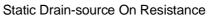


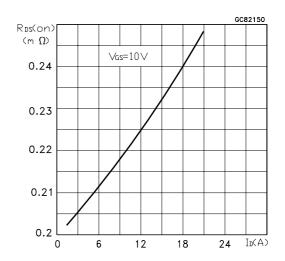
Gate Charge vs Gate-source Voltage

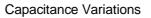


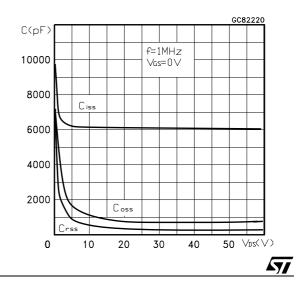
Transfer Characteristics



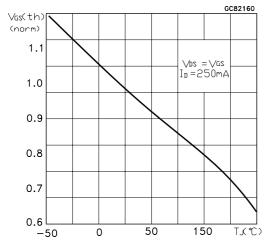




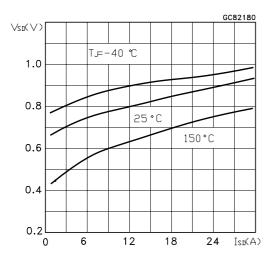




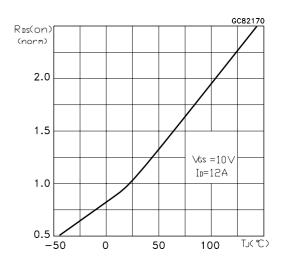
Normalized Gate Threshold Voltage vs Temperature



Source-drain Diode Forward Characteristics



Normalized On Resistance vs Temperature



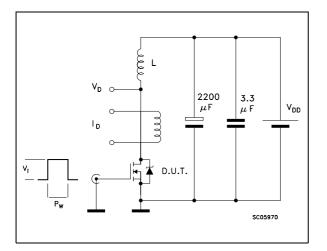
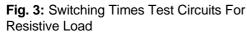


Fig. 1: Unclamped Inductive Load Test Circuit



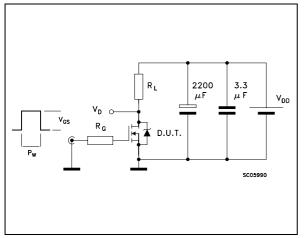


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

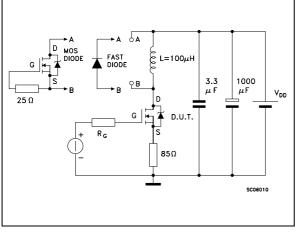


Fig. 2: Unclamped Inductive Waveform

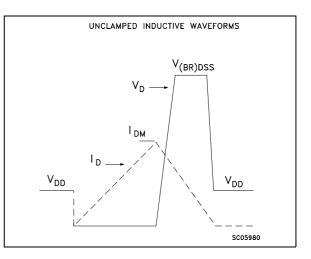
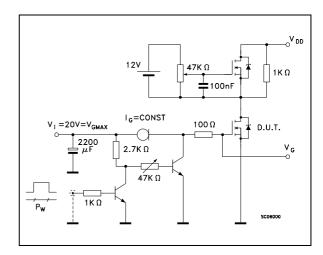


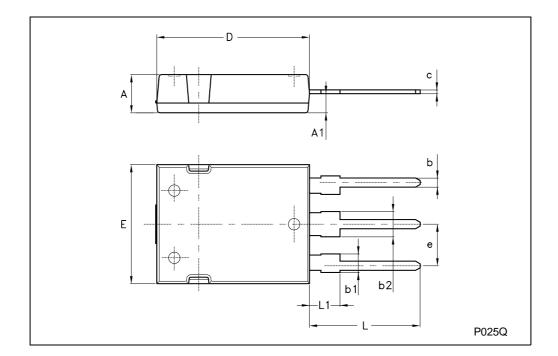
Fig. 4: Gate Charge test Circuit



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DIM.		mm			inch	
Dinii	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.70		5.30			
A1	2.20		2.60			
b	1.00		1.40			
b1	2.00		2.40			
b2	3.00		3.40			
с	0.40		0.80			
D	19.70		20.30			
е	5.35		5.55			
E	15.30		15.90			
L	14.20		15.20			
L1	3.70		4.30			

Max247 MECHANICAL DATA



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